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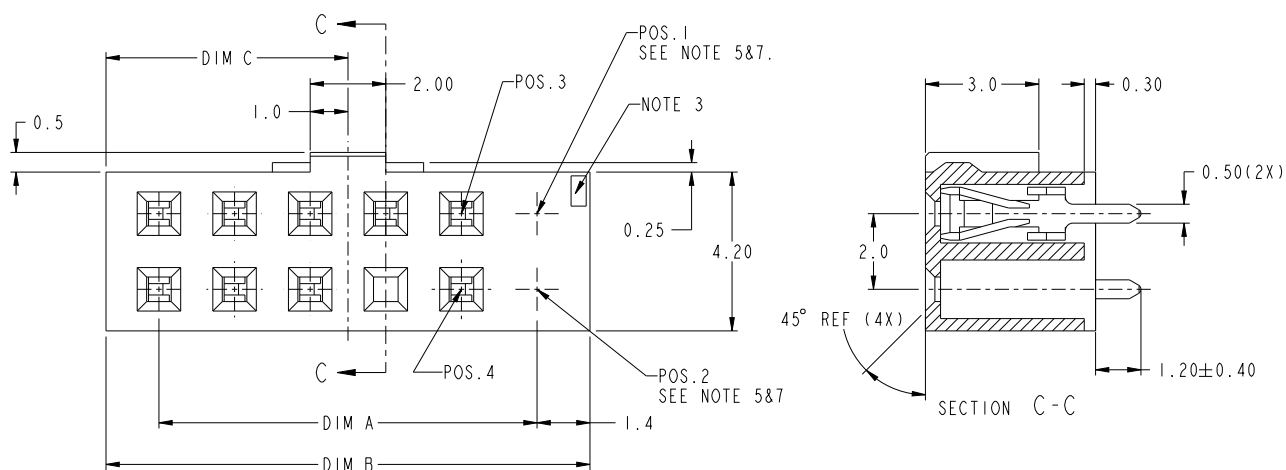
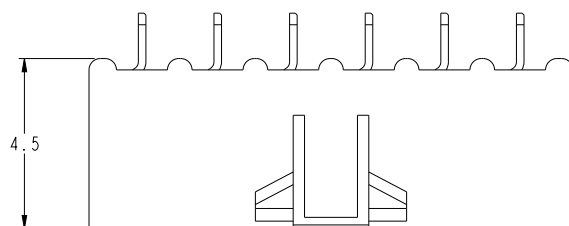
[FCI](#)

[63440-001LF](#)

For any questions, you can email us directly:

sales@integrated-circuit.com

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



spec ref		-		dr		Louis Ng		201012027		projection		MM		size		A3		scale		10:1	
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng		Andrew Yong		201106002						ecn no		ELK-S-001956-1		Released		rev	
ISO 406				chr		Aik-Peng Lim		201106003													
ISO 1101				appr		Chen-Hong Tan		201106003													
product family										MINITEK				rel level							
surface		✓		linear		0.X		±0.25				POL. MINITEK VCC WITH LATCHING		drg no		63440		sheet 1 of 2		L	
		0.XX		±0.13																	
		0.XXX		±0.05																	
ISO 1302		angular		0°		±0°		www.fci.com		cat. no.		-		Product - Customer Drw				sheet 1 of 2			

PRODUCT NO. NOTE 8	POS.	DIM A	DIM B	DIM C	POL. POS	TERM. DELETED
63440-X01	2 X 16	30.00	32.80	16.40	1,2,31,32	1,2,31,32
63440-X02	2 X 3	4.00	6.80	3.40	3	3
63440-X03	2 X 16	30.00	32.80	16.40	1,31	1,31
63440-X04	2 X 3	4.00	6.80	3.40	3	 3,4
63440-X05	2 X 6	10.00	12.80	6.40	1,2,11,12	1,2,11,12

PLATING	DESCRIPTION SEE NOTE 4
0	0.2µm/ 8µ" Au
1	0.76µm/ 30µ" Au
2	UNASSIGNED
3	0.38µm/ 15µ" Au

NOTES:

- HOUSING: PCT BEIGE UL 94V-0
- TERMINAL MATERIAL: PHOS BRONZE.
- SITE CODE TO BE LOCATED AS SHOWN.
- PLATING: Au OVER 1.27µm/50µ" Ni AT CONTACT.
- POLARISED POS REFER TO TABLE. SEE FIG.1 FOR SECTIONAL VIEW.
- TERMINALS TO BE DELETED REFER TO TABLE FOR POS.
- POLARISED AND TERMINAL DELETED IN THE SAME POSITION REFER TO FIGURE2.

- ⑧ PRODUCT DESCRIPTION CODE:
XXXXX-XXXLF

LEAD FREE (SEE NOTES 9 & 12)
TOTAL POSITIONS
CONTACT AREA PLATING
BASE NUMBER

- ⑨ SOLDER TAIL PLATING:
a) SOLDER TAIL OF P/N:63440-XXX IS TIN/LEAD PLATED.
b) SOLDER TAIL OF P/N:63440-XXXLF IS 100% MATTE TIN PLATED.

- 10 THE HOUSING WILL WITHSTAND EXPOSURE TO 250°C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

- 11 THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57MM MINIMUM THICK CIRCUIT BOARD.

- ⑫ THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 13  A SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

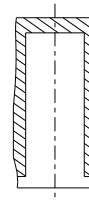


FIG.2

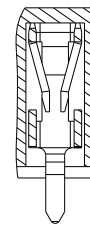


FIG.1

spec ref	-	dr	Lois Ng	20020827	projection	MM	size	A3	scale	10:1
tolerance std	ISO 406 ISO 1101	eng	Andrew Yung	20110602			ecn no	ELX-S-002596-1		
		chr	Alk-Pang Lim	20110603			rel level	Released		
		appr	Chen-Hong Tan	20110603						
surface	linear	0.X	±0.25		POL. MINITEK VCC WITH LATCHING					
		0.XX	±0.13							
		0.XXX	±0.05							
ISO 1302	angular	0°	±3°		cat. no.	-	Product - Customer Drw	sheet 2 of 2		